

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









ECS-.327-CDX-1128 SMD CRYSTAL



The ultra-minature ECS-.327-CDX-1128 is a very compact SMD Tuning Fork Crystal. The $3.2 \times 1.5 \times 0.9$ mm ceramic package is ideal for today's SMD manufacturing environment.

ECS-.327-CDX-1128



- Low Profile
- 3.2 x 1.5 mm Footprint
- Extended Temp. Range
- Low ESR
- RoHS Compliant

DIMENSIONS (mm)

OPERATING CONDITIONS / ELECTRICAL CHARACTERISTICS

PARAMETERS	CONDITIONS	ECS327-CDX-1128			UNITS
		MIN	TYP	MAX	
Frequency			32.768		KHz
Frequency Tolerance	@ +25°C			± 20	ppm
Temperature Coefficient		-0.028	-0.034	-0.040	ppm/°C²
Shunt Capacitance	Co			2.0	pF
Load Capacitance			6		рF
Drive Level	DL		0.1	0.5	μW
Equivalent Series Resistance	R1		55K	60K	Ω
Motional Capacitance	C1	3.0		4.4	fF
Crystal Q		13,000			
Turnover Temperature		+20	+25	+30	°C
Operating Temperature	Topr	-40		+85	°C
Storage Temperature	Tstg	-55		+125	°C
Aging (First Year)	@ +25°C ±3°C			±3	ppm
Insulation Resistance	@ 100Vdc ±15V	500M			Ω

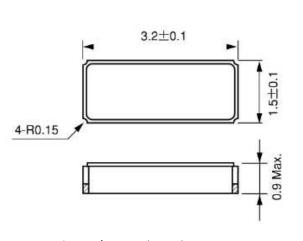
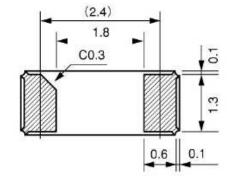


Figure 1) Top, Side, and Bottom views



PAD CONNECTIONS		
1	In/Out	
2	Out/In	

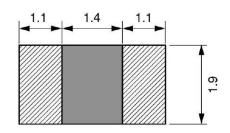
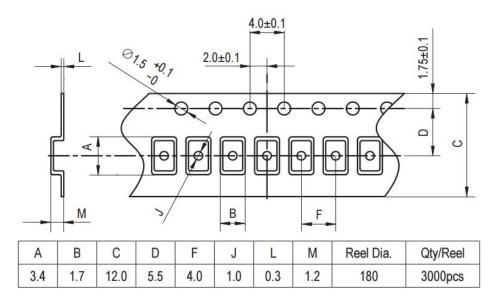


Figure 2) Suggested Land Pattern

PART NUMBER: Example ECS-.327-CDX-1128



POCKET TAPE DIMENSIONS (mm)



SOLDER PROFILE
Peak solder Temp +260°C Max 10 sec Max.
2 Cycles Max.
MSL 1, Lead Finish Au

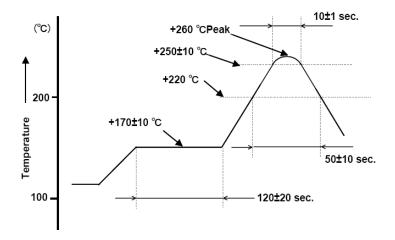


Figure 1) Suggested Reflow Profile